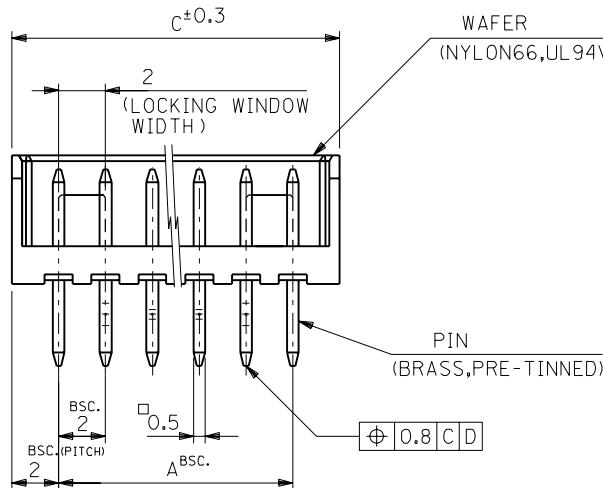
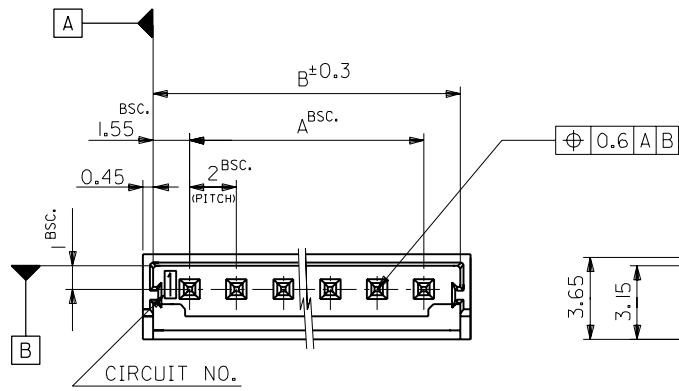


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ENG. NO.
SD-53253-**-10

EDP NO.

MM DIMENSIONS IN METRIC DO NOT SCALE DRAWING



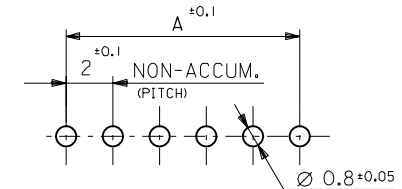
IN CASE OF
2 CIRCUIT WAFER

IN CASE OF
3 CIRCUIT WAFER

NOTES

1. MATES WITH: 51065-**-00
2. KINK TO BE APPLIED AS FOLLOWS, 2 CIRCUIT HAS NO KINK

CKT NO.	1	2	3	4	5	N-2	N-1	N
6 CKT	—	①	②	—	—	②	①	—
5 CKT	①	②	—	②	①	—	—	—
4 CKT	①	②	②	①	—	—	—	—
3 CKT	①	②	①	—	—	—	—	—



RECOMMENDED P.C. BOARD HOLE
DIMENSION (REFERENCE)
(t = 1.6)

32	31.1	28	53253-1510	15
30	29.1	26	-1410	14
28	27.1	24	-1310	13
26	25.1	22	-1210	12
24	23.1	20	-1110	11
22	21.1	18	-1010	10
20	19.1	16	-0910	9
18	17.1	14	-0810	8
16	15.1	12	-0710	7
14	13.1	10	-0610	6
12	11.1	8	-0510	5
10	9.1	6	-0410	4
8	7.1	4	-0310	3
6	5.1	2	53253-0210	2
C	B	A	ENG NO.	CKT

角度	ANGLE	°
30 以上	OVER	+30
10 以上 30 未満	OVER	+0.25
10 未満	UNDER	+0.2
一般公差	GENERAL TOLERANCES	

記号	変更内容	DR.	日付
1	REVISION RECORD	CHK.	DATE

材料	REFER TO DRAWING
仕上げ	REFER TO DRAWING
適用電線範囲	WIRE RANGE
被覆外径	INS. RANGE
DRAWN BY: 89/9/21	CHK'D BY: 89/9/21
S. AIHARA	M. FURUSHIMA
APP'D BY: 89/9/21	SCALE 5-1
M. ENOMOTO	

材料	MOLEX-JAPAN CO.,LTD.
日本モレックス株式会社	
EDP NO.	
ENG. NO.	SD-53253-**-10
REV	C
TITLE 名称	NEW 2.0 WIRE TO BOARD CONN. WAFER ASS'Y (ST.)

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